

## HIGH VOLTAGE POWER SCHOTTKY RECTIFIER

### MAIN PRODUCT CHARACTERISTICS

PRELIMINARY DATASHEET

$I_F(AV)$	2 x 10A
$V_{RRM}$	100V
$V_F$ (typ)	0.60V

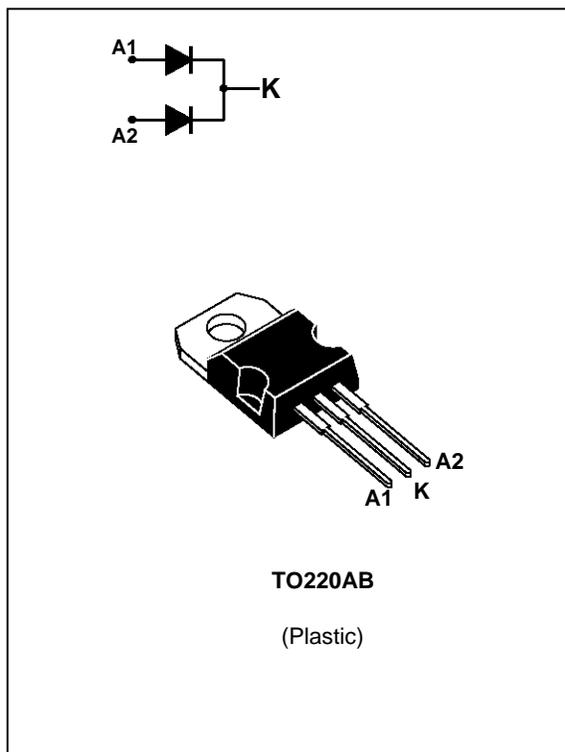
### FEATURES AND BENEFITS

- NEGLIGIBLE SWITCHING LOSSES
- LOW FORWARD VOLTAGE DROP
- LOW CAPACITANCE
- HIGH REVERSE AVALANCHE SURGE CAPABILITY

### DESCRIPTION

High voltage dual Schottky rectifier suited for switchmode power supplies and other power converters.

Packaged in TO220AC, this device is intended for use in medium voltage operation, and particularly, in high frequency circuitries where low switching losses and low noise are required.



### ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter		Value	Unit
$V_{RRM}$	Repetitive peak reverse voltage		100	V
$I_F(RMS)$	RMS forward current	Per diode	30	A
$I_F(AV)$	Average forward current	$T_c=110^\circ C$ $V_R = 60V$ $\delta = 0.5$ Per diode Per device	10 20	A A
$I_{FSM}$	Surge non repetitive forward current	$t_p=10ms$ sinusoidal Per diode	200	A
$I_{RRM}$	Repetitive peak reverse current	$t_p=2\mu s$ $F=1KHz$ Per diode	1	A
$I_{RSM}$	Non repetitive peak reverse current	$t_p=100\mu s$ Per diode	1	A
$T_{stg}$	Storage temperature range		- 65 to + 150	$^\circ C$
$T_j$	Max. Junction temperature		125	$^\circ C$
$dV/dt$	Critical rate of rise of reverse voltage		1000	V/ $\mu s$

**THERMAL RESISTANCES**

Symbol	Parameter		Value	Unit
Rth (j-c)	Junction to case	Per diode	1.6	°C/W
		Total	0.9	
Rth (c)	Coupling		0.15	°C/W

When the diodes 1 and 2 are used simultaneously :  
 $T_j - T_c(\text{diode } 1) = P(\text{diode } 1) \times R_{th(j-c)}(\text{Per diode}) + P(\text{diode } 2) \times R_{th(c)}$

**ELECTRICAL CHARACTERISTICS (Per diode)**

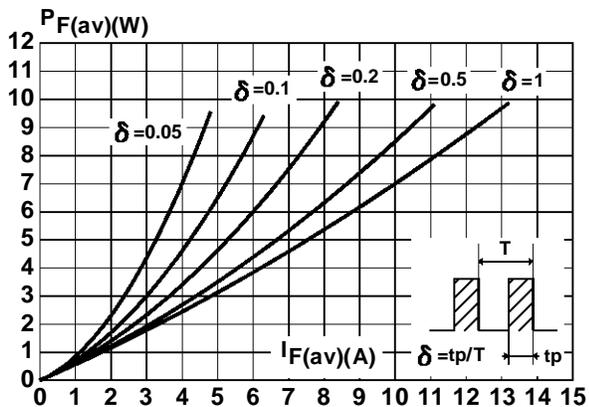
**STATIC CHARACTERISTICS**

Symbol	Parameter	Test Conditions		Min.	Typ.	Max.	Unit
I <sub>R</sub> *	Reverse leakage current	V <sub>R</sub> = V <sub>RRM</sub>	T <sub>j</sub> = 25°C			150	μA
			T <sub>j</sub> = 125°C			100	mA
V <sub>F</sub> **	Forward voltage drop	I <sub>F</sub> = 20 A	T <sub>j</sub> = 125°C			0.85	V
		I <sub>F</sub> = 10 A	T <sub>j</sub> = 125°C		0.60	0.70	
		I <sub>F</sub> = 20 A	T <sub>j</sub> = 25°C			0.95	

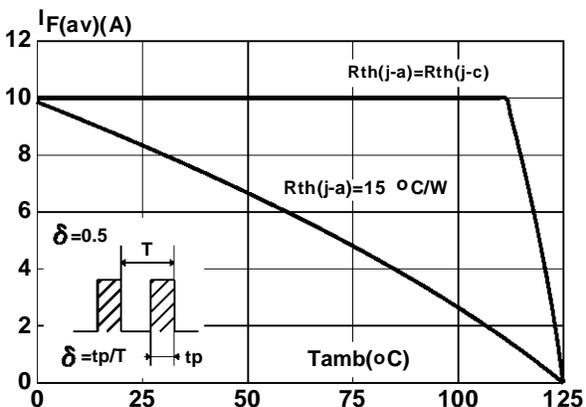
Pulse test : \* tp = 5 ms, duty cycle < 2 %  
 \*\* tp = 380 μs, duty cycle < 2 %

To evaluate the conduction losses use the following equation :  
 $P = 0.55 \times I_{F(AV)} + 0.015 \times I_{F(RMS)}^2$

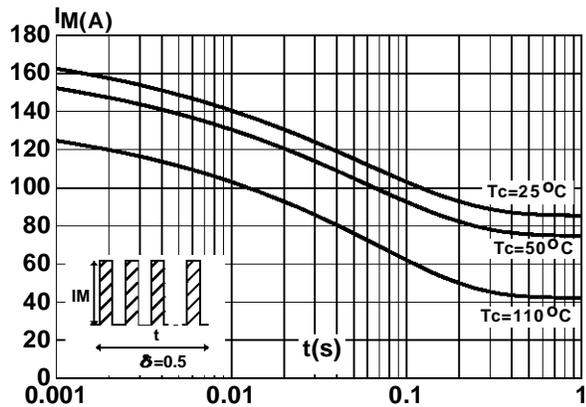
**Fig. 1 :** Average forward power dissipation versus average forward current. (Per diode)



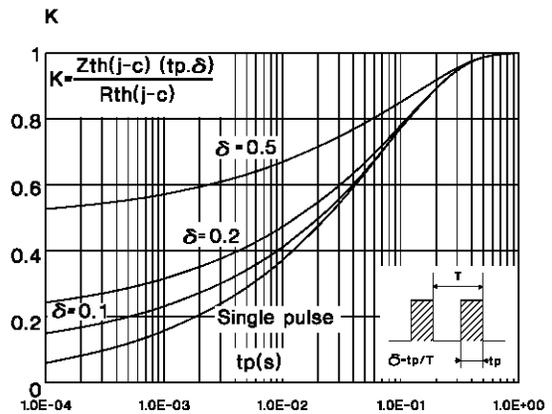
**Fig. 2 :** Average current versus ambient temperature. (duty cycle : 0.5) (Per diode)



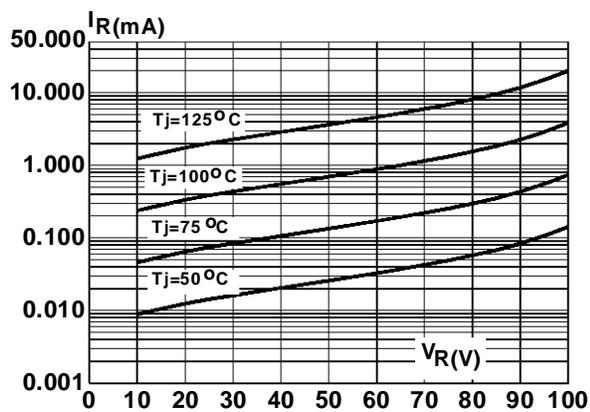
**Fig. 3 :** Non repetitive surge peak forward current versus overload duration. (Maximum values) (Per diode)



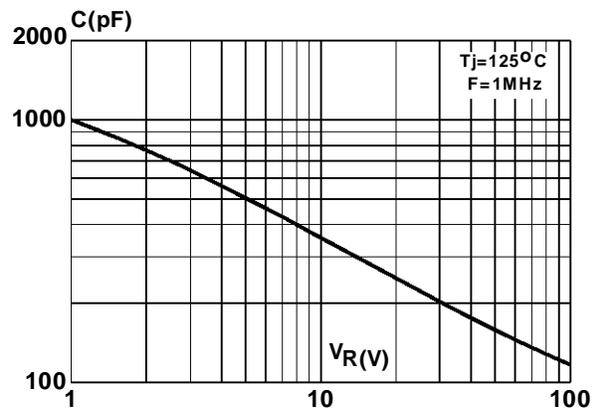
**Fig. 4 :** Relative variation of thermal transient impedance junction to case versus pulse duration.



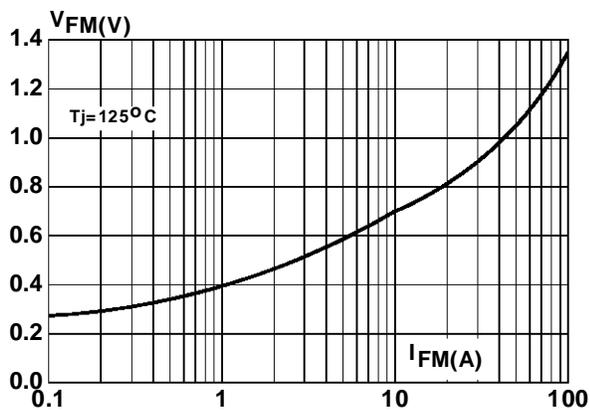
**Fig. 5 :** Reverse leakage current versus reverse voltage applied. (Typical values) (Per diode)



**Fig. 6 :** Junction capacitance versus reverse voltage applied. (Typical values) (Per diode)



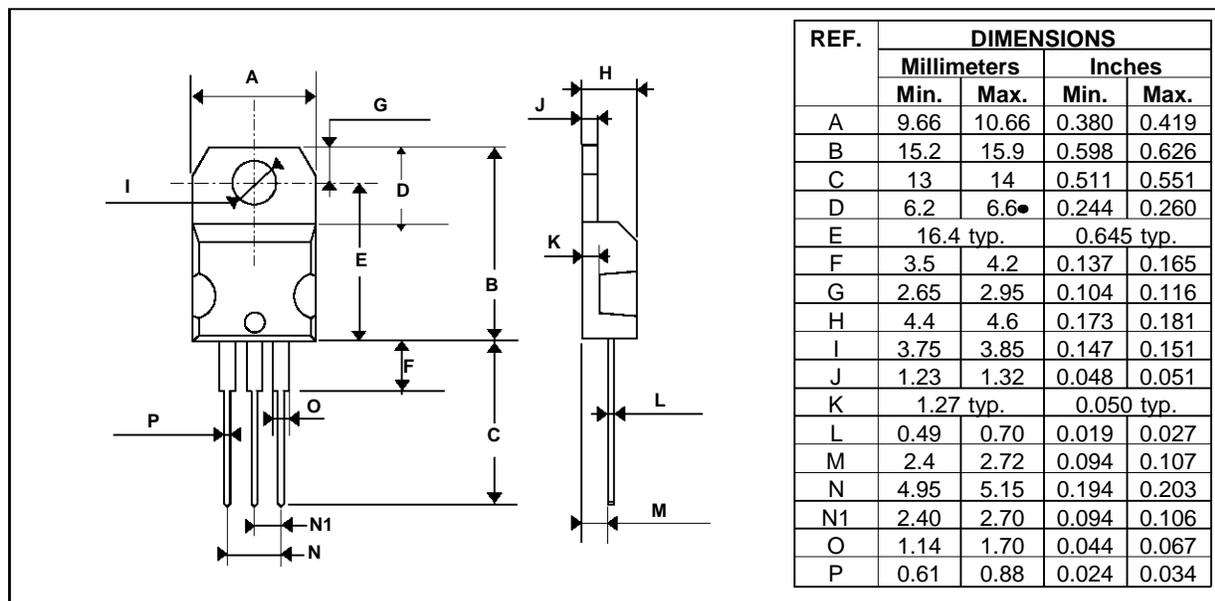
**Fig. 7 :** Forward voltage drop versus forward current. (Maximum values) (Per diode)



# STPS20100CT

## PACKAGE MECHANICAL DATA (millimeters )

TO220AB Plastic



Cooling method : by conduction (methode C)

Marking : Type number

Weigth : 2 g

Recommended torque value : 0.8m.N

Maximum torque value : 1m.N

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